

Features

- Fast Switching Speed: max. 50 ns
- High Reverse Breakdown Voltage: 300V
- Low Leakage Current: 100nA at room temperature
- Ultra Small Plastic SMD Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 5)**

Mechanical Data

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish - Matte Tin Annealed over Alloy 42 Leadframe.
- Solderable per MIL-STD-202, Method 208 
- Weight: 0.0014 grams (Approximate)

SOD523



Top View



Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging (Note 6)
BAS521Q-13	Automotive	SOD523	10,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.
 6. Dispensed in every other cavity of the tape.

Marking Information



99 = Product Type Marking Code
Bar Denotes Cathode Side

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	300	V
Working Peak Reverse Voltage	V _{RWM}	300	V
DC Blocking Voltage			
Forward Current (Note 7)	I _F	250	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs	I _{FSM}	4.5	A
Repetitive Peak Forward Current (Note 7)	I _{FRM}	1	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P _D	325	mW
Thermal Resistance Junction to Ambient Air (Note 7)	R _{θJA}	385	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	300	—	V	I _R = 100μA
Forward Voltage	V _F	—	1.1	V	I _F = 100mA
Reverse Current (Note 8)	I _R	—	50	nA	V _R = 5V
		—	150	nA	V _R = 250V
		—	100	μA	V _R = 250V, T _J = +150°C
Total Capacitance	C _T	—	5	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	50	ns	I _F = I _R = 30mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

Notes: 7. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
 8. Short duration pulse test used to minimize self-heating effect.

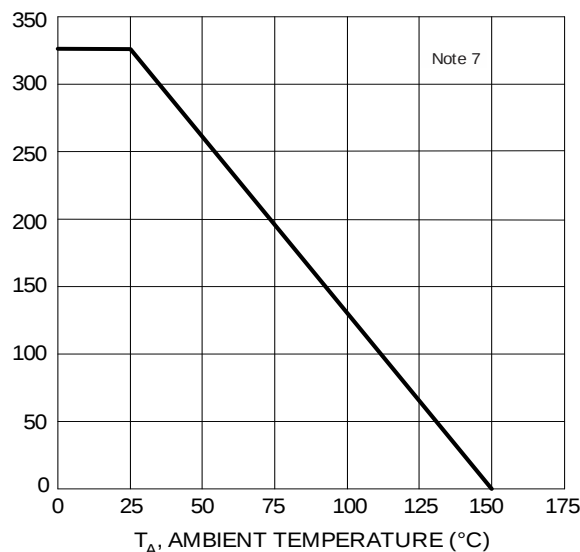


Figure 1 Power Derating Curve, Total Package

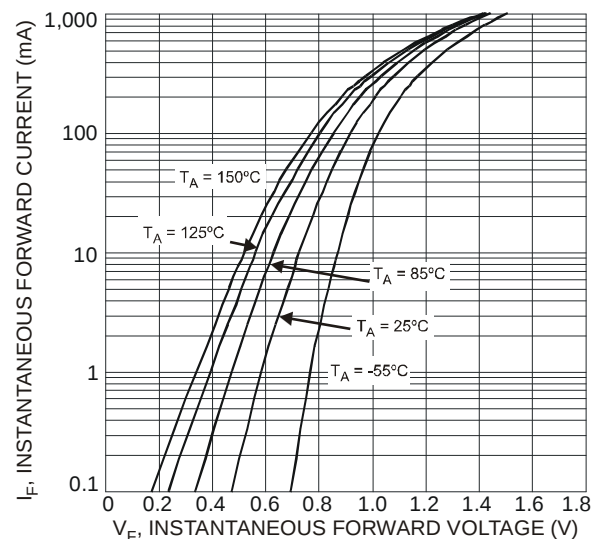


Fig. 2 Typical Forward Characteristics, Per Element

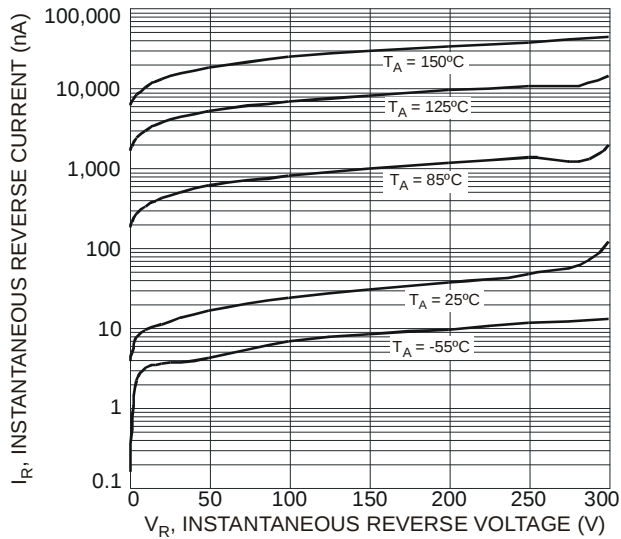


Fig. 3 Typical Reverse Characteristics, Per Element

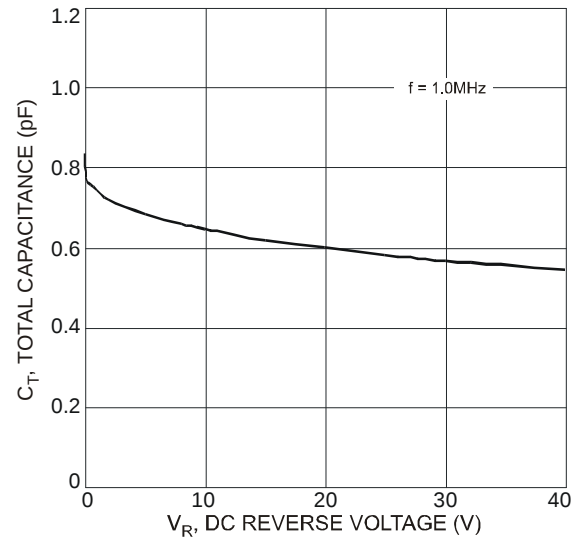
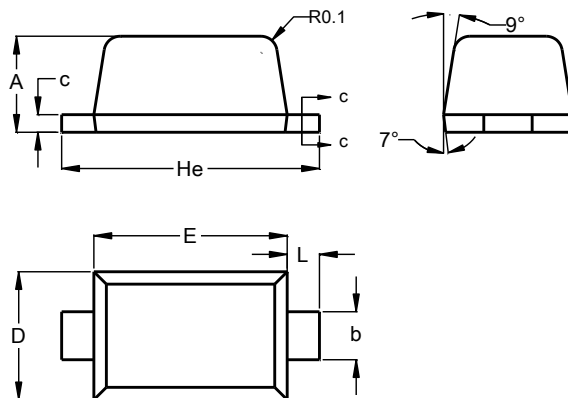


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

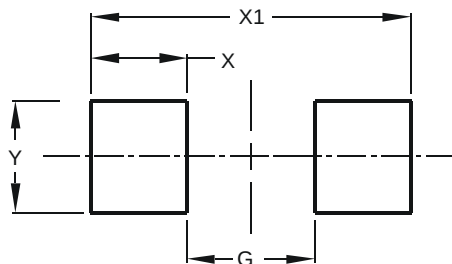
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOD523		
Dim	Min	Max
A	0.55	0.65
b	0.26	0.34
c	0.11	0.17
D	0.75	0.85
E	1.15	1.25
He	1.55	1.65
L	0.10	0.30
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
G	0.80
X	0.60
X1	2.00
Y	0.70

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